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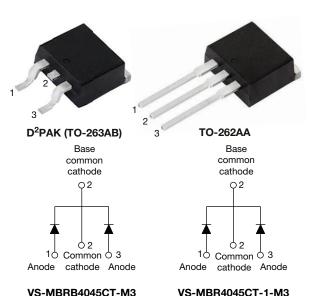
Vishay Semiconductors

COMPLIANT

HALOGEN

**FREE** 

## High Performance Schottky Rectifier, 2 x 20 A



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VS-MBR4045CT-1-M3

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	2 x 20 A				
$V_{R}$	45 V				
V <sub>F</sub> at I <sub>F</sub>	0.58 V				
I <sub>RM</sub> max.	95 mA at 125 °C				
T <sub>J</sub> max.	150 °C				
E <sub>AS</sub>	20 mJ				
Package	D <sup>2</sup> PAK (TO-263AB), TO-262AA				
Circuit configuration	Common cathode				

#### **FEATURES**

- 150 °C T<sub>J</sub> operation
- · Low forward voltage drop
- · High frequency operation
- Center tap TO-220, D2PAK and TO-262 packages
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- · Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

#### **DESCRIPTION**

The center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES								
I <sub>F(AV)</sub>	Rectangular waveform (per device)	40	۸					
I <sub>FRM</sub>	T <sub>C</sub> = 118 °C (per leg)	40	А					
$V_{RRM}$		45	V					
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	900	А					
V <sub>F</sub>	20 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.58	V					
T <sub>J</sub>	Range	-65 to +150	°C					

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-MBRB4045CT-M3 VS-MBR4045CT-1-M3	UNITS			
Maximum DC reverse voltage	$V_{R}$	45	V			
Maximum working peak reverse voltage	$V_{RWM}$	42	V			



# VS-MBRB4045CT-M3, VS-MBR4045CT-1-M3

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ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDI	TEST CONDITIONS		UNITS		
Maximum average per leg		T <sub>C</sub> = 118 °C, rated V <sub>B</sub>	.d.V				
forward current per device	$I_{C} = 118 ^{\circ}\text{C}$ , rated $V_{R}$			40			
Peak repetitive forward current per leg	I <sub>FRM</sub>	Rated V <sub>R</sub> , square wave, 20 kHz, T <sub>C</sub> = 118 °C		40	Α		
Maximum peak one cycle non-repetitive	1	5 μs sine or 3 μs rect. pulse Following any rated load condition and with		900			
peak surge current per leg	IFSM	10 ms sine or 6 ms rect. pulse	rated V <sub>RRM</sub> applied	210	İ		
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	$T_J = 25  ^{\circ}\text{C},  I_{AS} = 3  \text{A},  L = 4.4  \text{mH}$		20	mJ		
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		3	Α		

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS		
		20 A	T <sub>.1</sub> = 25 °C	0.60	V		
Maximum forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	40 A	11 = 23 0	0.78			
waximum forward voltage drop	VFM (')	20 A	T <sub>.1</sub> = 125 °C	0.58			
		40 A	1J = 125 C	0.75			
		T <sub>J</sub> = 25 °C		1	mA		
Maximum instantaneous reverse current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 100 °C	Rated DC voltage	50			
Tovorso durierit		T <sub>J</sub> = 125 °C		95			
Maximum junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal rang	ge 100 kHz to 1 MHz), 25 °C	900	pF		
Typical series inductance	L <sub>S</sub>	Measured from top of term	inal to mounting plane	8.0	nH		
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs		

#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300  $\mu s,$  duty cycle < 2 %

THERMAL - MECHANICAL	SPECIFIC	ATIONS			
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		UNITS	
Maximum junction temperature range	TJ		-65 to 150	°C	
Maximum storage temperature range	T <sub>Stg</sub>		-65 to 175	C	
Maximum thermal resistance, junction to case per leg	R <sub>thJC</sub>	DC operation	1.5		
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth, and greased (Only for TO-220)	0.50	°C/W	
Maximum thermal resistance, junction to ambient	R <sub>thJA</sub>	DC operation (For D <sup>2</sup> PAK and TO-262)	50		
Approximate weight			2	g	
Approximate weight			0.07	oz.	
Maurating targue minimum		Non-lubricated threads	6 (5)	kgf · cm	
Mounting torque maximum		NOTI-TUDITICATED THEADS	12 (10)	(lbf $\cdot$ in)	
Marking daying		Case style D <sup>2</sup> PAK (TO-263AB)	MBRB4	1045CT	
Marking device		Case style TO-262	MBR4045CT-1		

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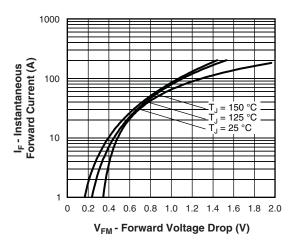


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

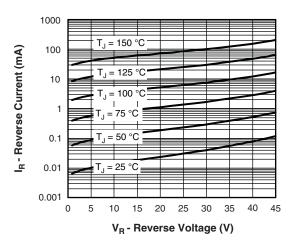


Fig. 2 - Typical Values of Reverse Current vs.Reverse Voltage (Per Leg)

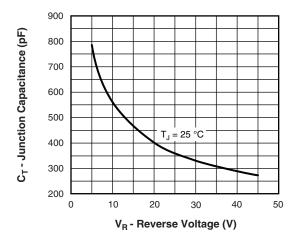


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

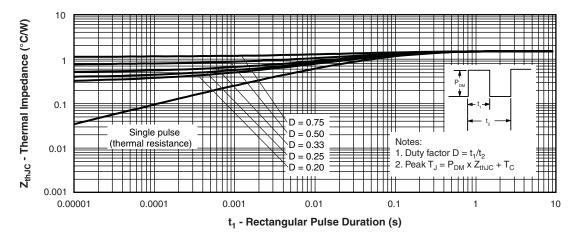


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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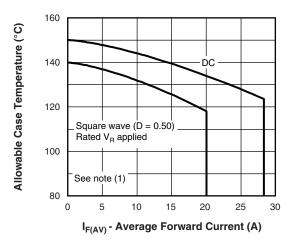


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

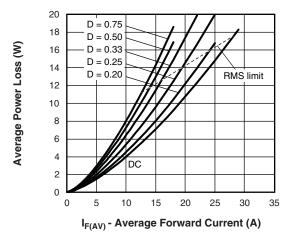


Fig. 6 - Forward Power Loss Characteristics

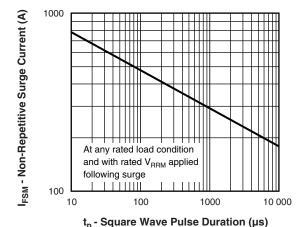


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

#### Note

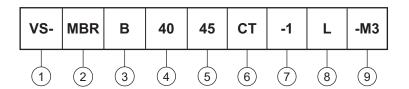
 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D)}; \ I_R \text{ at } V_{R1} = \text{rated } V_R \\ \end{array}$ 

## VS-MBRB4045CT-M3, VS-MBR4045CT-1-M3

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#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Essential part number

3 - • B = D<sup>2</sup>PAK **7** None

• None = TO-262 7 = -1

- Current rating (40 = 40 A)

5 - Voltage rating (45 = 45 V)

6 - CT = essential part number

- • None =  $D^2PAK$  3 = B

• -1 = TO-262 **3** None

8 - • None = tube

• L = tape and reel (left oriented - for D<sup>2</sup>PAK only)

• R = tape and reel (right oriented - for D<sup>2</sup>PAK only)

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-MBRB4045CT-M3	50	1000	Antistatic plastic tube			
VS-MBRB4045CTR-M3	800	800	13" diameter reel			
VS-MBRB4045CTL-M3	800	800	13" diameter reel			
VS-MBR4045CT-1-M3	50	1000	Antistatic plastic tube			

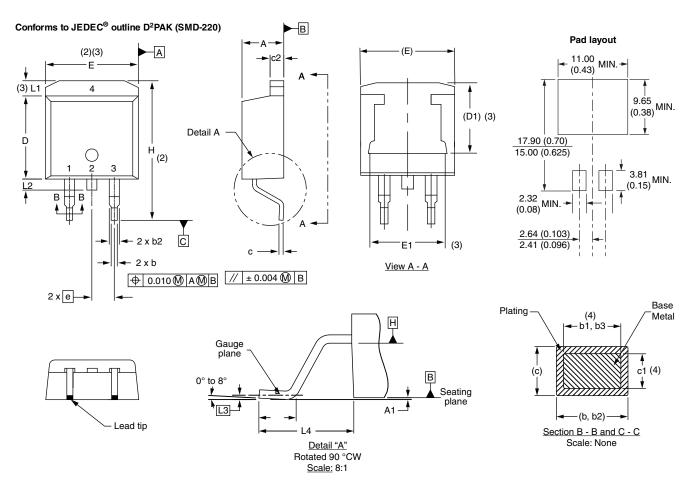
LINKS TO RELATED DOCUMENTS							
Dimensions —	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?96164					
Differsions	TO-262AA	www.vishay.com/doc?96165					
Dout manding information	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?95444					
Part marking information —	TO-262AA	www.vishay.com/doc?95443					
Packaging information		www.vishay.com/doc?96424					
SPICE model		www.vishay.com/doc?95296					



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### D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	ETERS	INC	HES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

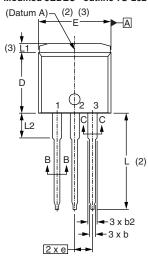
Revision: 13-Jul-17 **1** Document Number: 96164

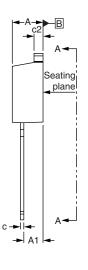
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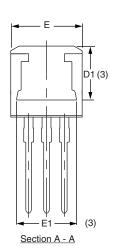
### **TO-262AA**

#### **DIMENSIONS** in millimeters and inches

#### Modified JEDEC® outline TO-262







**⊕** 0.010 **M** A**M** B

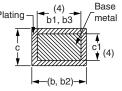
#### Lead assignments



**Diodes** 1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
OTMIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC	BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

#### **Notes**

(4) Dimension b1 and c1 apply to base metal only

Controlling dimension: inches

Revision: 30-Nov-17 Document Number: 96165

<sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

Thermal pad contour optional within dimension E, L1, D1 and E1

Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)



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